



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 6334**
Koji MISHIMA et al. : Attorney Docket No. 2003_1305
Serial No. 10/660,483 : Group Art Unit 1742
Filed September 12, 2003 : Examiner William T. Leader

METHOD AND APPARATUS FOR PLATING
SUBSTRATE WITH COPPER

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

Responsive to the Office Action dated July 12, 2005, the period for response to which
having been extended by three-months to January 12, 2006, please amend the above-identified
application as follows.